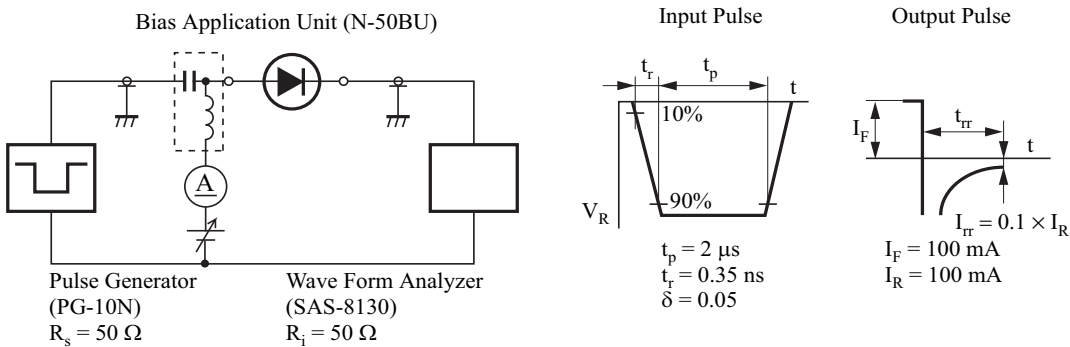




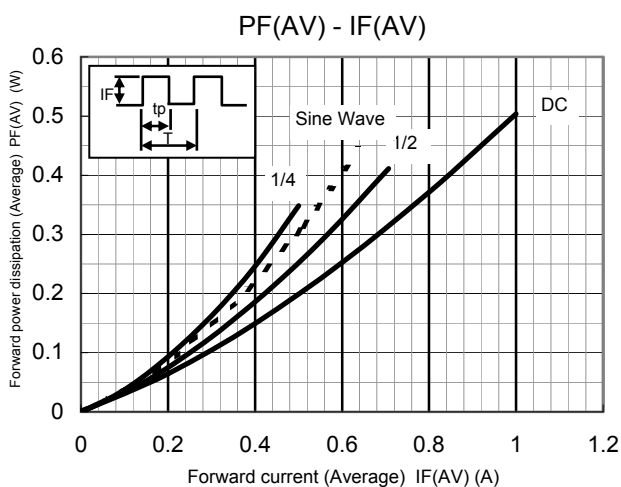
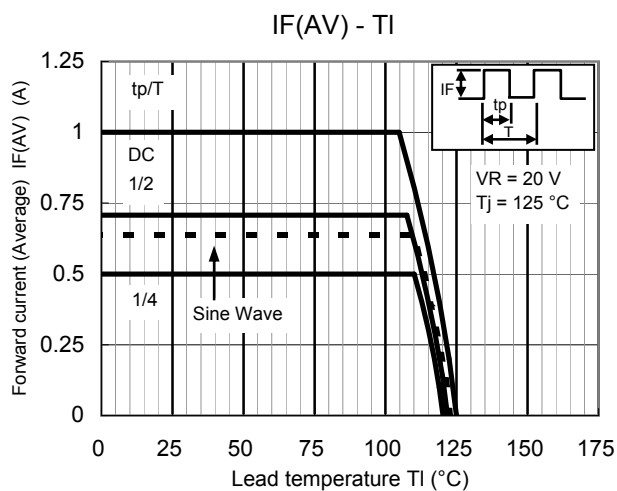
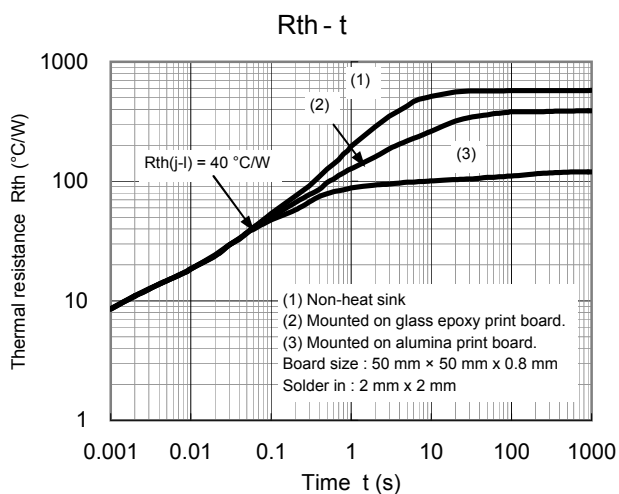
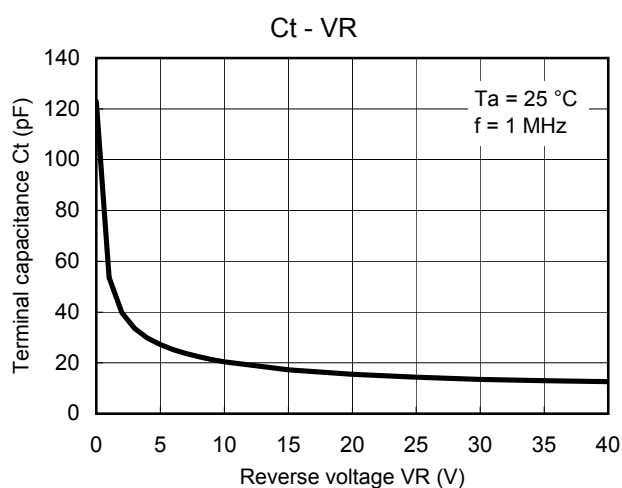
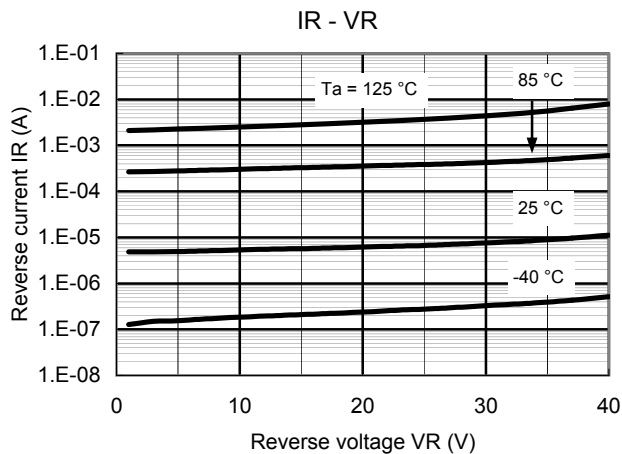
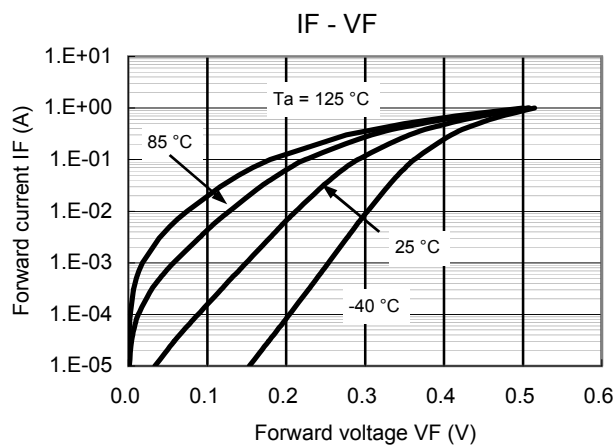
■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Forward voltage	VF	IF = 1 A		0.50	0.58	V
Reverse current	IR	VR = 40 V		15	100	μA
Terminal capacitance	Ct	VR = 10 V, f = 1 MHz		21		pF
Reverse recovery time *1	trr	IF = IR = 100 mA, Irr = 0.1 × IR		6.8		ns

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
3. *1 trr test circuit



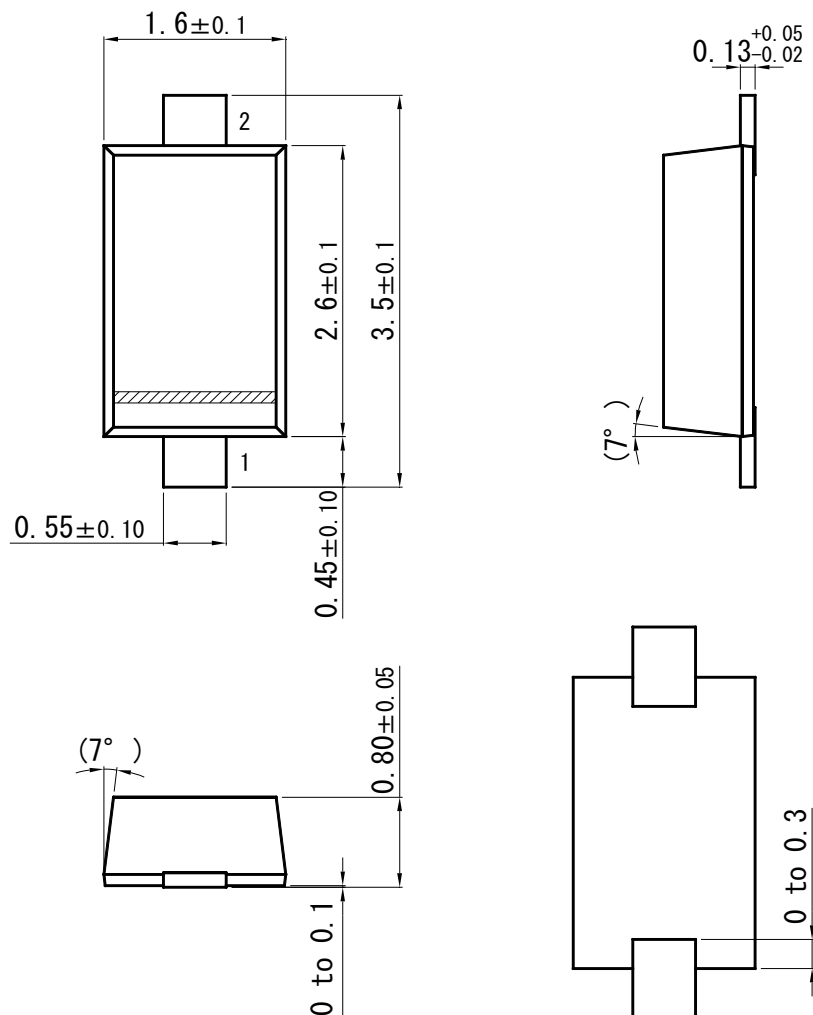
Technical Data (reference)



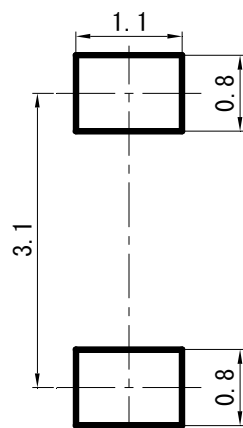
Panasonic

Mini2-F4-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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